

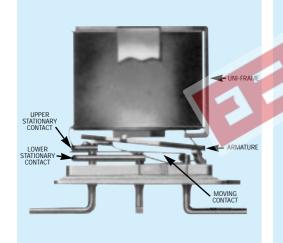


# **CENTIGRID® SURFACE MOUNT COMMERCIAL RELAY DPDT**

**SERIES S172** 

| SERIES<br>DESIGNATION | RELAY TYPE  |  |
|-----------------------|---|--|
| S172                  | DPDT basic relay  |  |
| S172D                 | DPDT relay with internal diode for coil transient suppression |  |

#### INTERNAL CONSTRUCTION



| ENVIRONMENTAL AND PHYSICAL SPECIFICATIONS |   |  |  |  |  |
|---|---|--|--|--|--|
| Temperature<br>(Ambient)                  | -55°C to +85°C                              |  |  |  |  |
| Vibration                                 | 10 g's to 500 Hz (Note 3)                   |  |  |  |  |
| Shock                                     | 30 g's for 6 msec. (Note 3) half-sine       |  |  |  |  |
| Enclosure                                 | All welded, hermetically sealed             |  |  |  |  |
| Weight                                    | 0.15 oz (4.3 gms.) max.                     |  |  |  |  |
| Reflow<br>Temperature                     | 260°C max. temp.<br>5 min. max. above 180°C |  |  |  |  |

DESCRIPTION
The S172 Surface A The S172 Surface Mount Centigrid® relay is an ultraminiature, hermetically sealed, armature relay for commercial applications. Its low profile height (.470) and .100" grid spaced terminals, which precludes the need for spreader pads, makes it an ideal choice where extreme packaging density and/or close PC board spacing are required. The specially formed leads are pre-tinned to make the relays ideal for all types of surface mount solder reflow processes.

The basic design and internal structure are similar to the Teledyne DPDT Centigrid® relay (114 Series). Unique construction features and manufacturing techniques provide overall high reliability and excellent resistance to environmental extremes:

- · All welded construction.
- · Unique uni-frame design providing high magnetic efficiency and mechanical rigidity.
- · High force/mass ratios for resistance to shock and vibration.
- Advanced cleaning techniques provide maximum assurance of internal cleanliness.
- · Precious metal alloy contact material with gold plating assures excellent high current and dry circuit switching capabilities.

The S172 Series utilizes an internal discrete silicon diodes for coil suppression with electrical characteristics as specified herein.

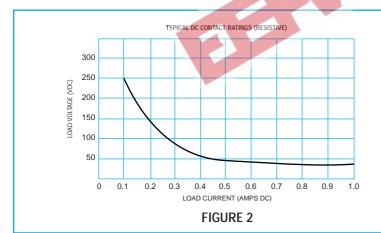
By virtue of its inherently low intercontact capacitance and contact circuit losses, the S172 relay is an excellent subminiature RF switch for frequency ranges well into the UHF spectrum (see Figure 1). Applications include telecommunications, test instruments, mobile communications, attenuators, and automatic test equipment.

#### GENERAL ELECTRICAL SPECIFICATIONS (@ 25°C) (Notes 1 & 2)

| Contact Arrangement   | 2 Form C (DPDT)   |                      |  |  |
|---|---|----------------------|--|--|
| Rated Duty  | Continuous  |                      |  |  |
| Contact Resistance  | 0.15 ohm max. before life; 0.3 ohm max. after life at 1A/28VDC, (measured 1/8" from header)   |                      |  |  |
| Contact Load Ratings (DC)<br>(See Fig. 2 for other DC<br>resistive voltage/current ratings) | Resistive: 1 Amp/28VDC<br>Inductive: 200 mA/28VDC (320 mH)<br>Lamp: 100 mA/28VDC<br>Low Level: 10 to 50 µA/10 to 50 mV                                |                      |  |  |
| Contact Life Ratings  | 5,000,000 cycles (typical) at low level<br>500,000 cycles (typical) at 0.5A/28VDC resistive<br>100,000 cycles min. at all other loads specified above |                      |  |  |
| Contact Overload Rating   | 2A/28VDC Resistive (100 cycles min.)  |                      |  |  |
| Contact Carry Rating  | Contact factory   |                      |  |  |
| Operate Time  | 6.0 msec max. at nominal rated coil voltage   |                      |  |  |
| Release Time  | S172: 3.0 msec max.   | S172D: 6.0 msec max. |  |  |
| Intercontact Capacitance  | 0.4 pf typical  |                      |  |  |
| Insulation Resistance   | 1,000 megohms min. between mutually isolated terminals  |                      |  |  |
| Dielectric Strength   | Atmospheric pressure: 300 VRMS/60 Hz  |                      |  |  |
| Diode P.I.V. S172D  | 60 VDC Min.   |                      |  |  |
| Negative Coil Transient S172D   | 2.0 VDC Max.  |                      |  |  |

### DETAILED ELECTRICAL SPECIFICATIONS (@ 25°C) (Note 2)

|  | S172-5<br>S172 <b>D</b> -5 | \$172-12<br>\$172D-12 | S172-26<br>S172D-26 |      |
|--|----------------------------|-----------------------|---------------------|------|
| Coil Voltage (VDC)                                   | Nom.                       | 5.0                   | 12.0                | 26.5 |
|  | Max.                       | 5.8                   | 16.0                | 32.0 |
| Coil Resistance (Ohms ± 20%)                         |                            | 64                    | 400                 | 1600 |
| Pick-up Voltage (VDC, Max.) Pulse Operation          |                            | 3.8                   | 9.0                 | 18.0 |
| Coil Operating Power at Nominal Voltage (Milliwatts) |                            | 405                   | 360                 | 440  |



## NOTES:

- Characteristics shown as "typical" are based on available data and are best estimates. No on-going verification tests are performed.
- Unless otherwise specified, parameters are initial values.
- 3. Relay contacts will exhibit no chatter in excess of 10 µsec or transfer in excess of 1 µsec.
- 4. Position of leads as they emerge from relay base.
- 5. Leads will fit noted pad layout with no overhang.
- Lead ends are coplanar within .008" wide tolerance zone.
- Terminals coated with SN60 or SN63 solder per QQ-S-571. Base material exposed at sheared end of leads.

